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LV5684NPVD

Bi-CMOS IC

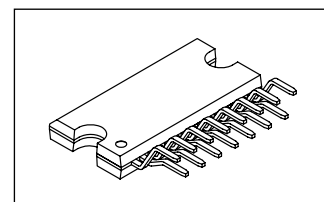
System Power Supply IC for Automotive Infotainment Multiple Output Linear Voltage Regulator

Overview

The LV5684NPVD is a multiple output linear regulator IC, which allows reduction of quiescent current. The LV5684NPVD is specifically designed to address automotive infotainment systems power supply requirements. The LV5684NPVD integrates 5 linear regulator outputs, 2 high side power switches, over-current limiter, overvoltage protection and thermal shut down. Supply for VDD and SW33V outputs is low voltage specification, which enables drastic reduction of power dissipation compared to the existing model.

Function

- Low consumption current: 50 μ A (typ, only VDD output is in operation)
- 5 systems of regulator output
 - VDD for microcontroller: output voltage: 3.3V,
maximum output current: 350mA .
 - For system: output voltage: 3.3V, maximum output current: 450mA
 - For audio: output voltage: 5 to 12V (set by external resistors),
maximum output current: 250mA
 - For illumination: output voltage: 5 to 12V (set by external resistors),
maximum output current: 300mA
 - For CD: output voltage: 5V/8V, maximum output current: 1300mA
- 2 lines of high side switch with current protection
 - EXT: Maximum output current: 350mA,
voltage difference between input and output: 0.5V
 - ANT: Maximum output current: 300mA,
voltage difference between input and output: 0.5V
- Supply input
 - V6IN: 6V for VDD, system (SW33V)
 - VCC1: For internal reference voltage, control circuits
In case of voltage drop of V6IN, VCC1 supplies to VDD output.
 - VCC2: For AUDIO, illumination, CD, EXT/ANT
- Over-current limiter
- Overvoltage protector(OVP): VCC1, VCC2 Typ 23V (All outputs except VDD are turned off)
Overvoltage shutdown(OVS): V6IN Typ 23V (All outputs except VDD are turned off)
- Thermal shut down : Typ 175°C



HZIP15

(Warning) The protector functions only improve the IC's tolerance and they do not guarantee the safety of the IC if used under the conditions out of safety range or ratings. Use of the IC such as use under overcurrent protection range, thermal shutdown state or V6IN OVS condition may degrade the IC's reliability and eventually damage the IC.

ORDERING INFORMATION

See detailed ordering and shipping information on page 15 of this data sheet.

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Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

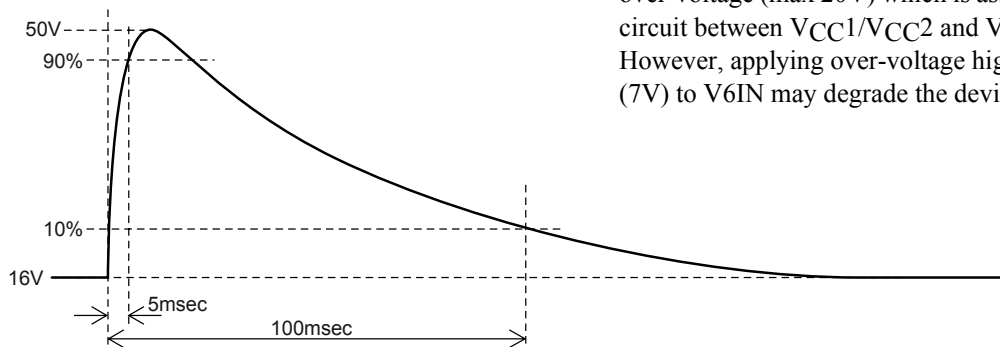
Parameter	Symbol	Conditions	Ratings	Unit	
Supply voltage	V_{CC} max	V_{CC1}, V_{CC2}	36	V	
	V_{6IN} max	$V_{6IN} (*)$	7	V	
Input voltage	V_{IN} max	CTRL1, CTRL2	7	V	
Allowable power dissipation	P_d max	Independent IC	$T_a \leq 25^\circ\text{C}$	1.3	W
		Al heat sink *		5.3	W
		With an infinity heat sink		26	W
Peak supply voltage	V_{CC} peak	See below for the waveform applied.	50	V	
Operating ambient temperature	T_{opr}		-40 to +85	$^\circ\text{C}$	
Storage temperature	T_{stg}		-55 to +150	$^\circ\text{C}$	
Junction temperature	T_j max		150	$^\circ\text{C}$	

* : When the Aluminum heat sink (50mm × 50mm × 1.5mm) is used

Caution 1) Absolute maximum ratings represent the value which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

Waveform of surge test (V_{CC1}, V_{CC2})



* V_{6IN} is designed to tolerant toward short period of over-voltage (max 20V) which is assumed in condition of short circuit between V_{CC1}/V_{CC2} and V_{6IN} . However, applying over-voltage higher than maximum rating (7V) to V_{6IN} may degrade the device reliability

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Recommended Operating Conditions at $T_a = 25^\circ\text{C}$

V_{CC1}

Parameter	Conditions	Ratings	Unit
Operating supply voltage 1	V_{DD} output	7 to 16	V

V_{CC2}

Parameter	Conditions	Ratings	Unit
Operating supply voltage 2	ILM output (10V)	12 to 16	V
	ILM output (8V)	10 to 16	V
Operating supply voltage 3	AUDIO output (9V)	10 to 16	V
Operating supply voltage 4	CD output ($I_O = 1.3A$)	10.5 to 16	V
	CD output ($I_O \leq 1A$)	10 to 16	V
Operating supply voltage 5	EXT output, ANT output	10 to 16	V

V_{6IN}

Parameter	Conditions	Ratings	Unit
Operating supply voltage 6	V_{DD} output, SW33V output	5.7 to 6.5	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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Electrical Characteristics at $V_{CC1} = V_{CC2} = 14.4V$, $V_{6IN} = 6V$ at $T_a = 25^\circ C$ (*1)

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Quiescent current	I_{CC}	V_{DD} w/out load, CTRL1/2 = "L/L"		50	100	μA
CTRL1 input (ANT/EXT/ILM)						
Low input voltage	V_{IL1}		0		0.5	V
M1 input voltage	V_{IM1}		0.8	1.1	1.4	V
M2 input voltage	V_{IM2}		1.9	2.2	2.5	V
High input voltage	V_{IH1}		2.9	3.3	5.5	V
Input impedance	R_{IH1}	input voltage $\leq 3.3V$	280	400	480	$k\Omega$
CTRL2 input (CD/AUDIO/SW33V)						
Low input voltage	V_{IL2}		0		0.5	V
M1 input voltage	V_{IM2}		0.8	1.1	1.4	V
M2 input voltage	V_{IM2}		1.9	2.2	2.5	V
High input voltage	V_{IH2}		2.9	3.3	5.5	V
Input impedance	R_{IH2}	input voltage $\leq 3.3V$	280	400	480	$k\Omega$
V_{DD} output (3.3V)						
Output voltage	V_{O1}	$I_{O1} = 200mA$	3.13	3.3	3.47	V
Output current	I_{O1}	$V_{O1} \geq 3.1V$	350			mA
Line regulation	ΔV_{OLN1}	$5.7V < V_{6IN} < 6.5V$, $I_{O1} = 200mA$ or $V_{6IN} = 0V$, $7.5V < V_{CC1} < 16V$, $I_{O1} = 200mA$		30	90	mV
Load regulation	ΔV_{OLD1}	$1mA < I_{O1} < 200mA$		70	150	mV
Dropout voltage	V_{DROP1}	$I_{O1} = 200mA$, $V_{6IN} = 0V$ (applicable to V_{CC1})		1.9	2.8	V
Ripple rejection (*2)	R_{REJ1}	$f = 120Hz$, V_{6IN} or $V_{CC1} = 0.5V_{pp}$ $I_{O1} = 200mA$	40	50		dB
SW33V output (3.3V) ; CTRL2 = "M1 or M2 or H"						
Output voltage	V_{O2}	$I_{O2} = 200mA$	3.13	3.3	3.47	V
Output current	I_{O2}	$V_{O2} \geq 3.1V$	450			mA
Line regulation	ΔV_{OLN2}	$5.7V < V_{6IN} < 6.5V$, $I_{O2} = 200mA$		30	90	mV
Load regulation	ΔV_{OLD2}	$1mA < I_{O2} < 200mA$		70	150	mV
Dropout voltage	V_{DROP2}	$I_{O2} = 200mA$		0.25	0.5	V
Ripple rejection (*2)	R_{REJ2}	$f = 120Hz$, V_{6IN} or $V_{CC1} = 0.5V_{pp}$ $I_{O2} = 200mA$	40	50		dB
AUDIO (5-12V)output ; CTRL2 = "M1 or M2 or H"						
AUDIO_F voltage	V_{I3}		1.212	1.25	1.288	V
AUDIO_F input current	I_{IN3}		-1		1	μA
AUDIO output voltage 1	V_{O3}	$I_{O3} = 200mA$, $R1 = 43k\Omega$, $R2 = 5.1k\Omega$ (*3)	11.21	11.8	12.39	V
AUDIO output voltage 2	$V_{O3'}$	$I_{O3} = 150mA$, $R3 = 27k\Omega$, $R4 = 4.7k\Omega$ (*3)	8.13	8.5	8.87	V
AUDIO output voltage 3	$V_{O3''}$	$I_{O3} = 150mA$, $R3 = 30k\Omega$, $R4 = 10k\Omega$ (*3)	4.75	5.0	5.25	V
AUDIO output current	I_{O3}		250			mA
Line regulation	ΔV_{OLN3}	$10V < V_{CC2} < 16V$, $I_{O3} = 150mA$		30	90	mV
Load regulation	ΔV_{OLD3}	$1mA < I_{O3} < 150mA$		70	150	mV
Dropout voltage 1	V_{DROP3}	$I_{O3} = 150mA$		0.3	0.45	V
Ripple rejection (*2)	R_{REJ3}	$f = 120Hz$, $I_{O3} = 150mA$	40	50		dB
ILM (5-12V) output ; CTRL1 = "M1 or M2 or H"						
ILM_F voltage	V_{I4}		1.212	1.25	1.288	V
ILM_F input current	I_{IN4}		-1		1	μA
ILM output voltage 1	V_{O4}	$I_{O4} = 200mA$, $R1 = 43k\Omega$, $R2 = 5.1k\Omega$ (*3)	11.21	11.8	12.39	V
ILM output voltage 2	$V_{O4'}$	$I_{O4} = 200mA$, $R1 = 56k\Omega$, $R2 = 7.5k\Omega$ (*3)	9.97	10.5	11.03	V
ILM output voltage 3	$V_{O4''}$	$I_{O4} = 200mA$, $R1 = 30k\Omega$, $R2 = 5.6k\Omega$ (*3)	7.6	8.0	8.4	V
ILM output voltage 4	$V_{O4'''}$	$I_{O4} = 200mA$, $R1 = 30k\Omega$, $R2 = 10k\Omega$ (*3)	4.75	5.0	5.25	V
ILM output current	I_{O4}		300			mA

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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Line regulation	ΔV_{OLN4}	$10V < V_{CC2} < 16V, I_{O4} = 200mA$ $R1 = 30k\Omega, R2 = 5.6k\Omega$		30	90	mV
Load regulation	ΔV_{OLD4}	$1mA < I_{O4} < 200mA$		70	150	mV
Dropout voltage 1	V_{DROP4}	$I_{O4} = 200mA$		0.7	1.05	V
Dropout voltage 2	V_{DROP4}'	$I_{O4} = 100mA$		0.35	0.53	V
Ripple rejection (*2)	R_{REJ4}	$f = 120Hz, I_{O4} = 200mA$	40	50		dB
CD (5V/8V output) ; CTRL2 = "H" : 8V, CTRL2 = "M2" : 5V						
Output voltage	V_{O51}	$I_{O5} = 1000mA$	4.75	5.0	5.25	V
	V_{O52}	$I_{O5} = 1000mA$	7.6	8.0	8.4	V
Output current	I_{O5}	$V_{O51} \geq 4.7V, V_{O52} \geq 7.6V$	1300			mA
Line regulation	ΔV_{OLN5}	$10.5V < V_{CC2} < 16V, I_{O5} = 1000mA$		50	100	mV
Load regulation	ΔV_{OLD5}	$10mA < I_{O5} < 1000mA$		100	200	mV
Dropout voltage 1	V_{DROP5}	$I_{O5} = 1000mA$		1.0	1.5	V
Dropout voltage 2	V_{DROP5}'	$I_{O5} = 500mA$		0.5	0.75	V
Ripple rejection (*2)	R_{REJ5}	$f = 120Hz, I_{O5} = 1000mA$	40	50		dB
EXT_HS-SW ; CTRL1 = "M2 or H"						
Output voltage	V_{O6}	$I_{O6} = 350mA$	$V_{CC2-1.0}$	$V_{CC2-0.5}$		V
Output current	I_{O6}	$V_{O6} \geq V_{CC2-1.0}$	350			mA
ANT_HS-SW ; CTRL1 = "H"						
Output voltage	V_{O7}	$I_{O7} = 300mA$	$V_{CC2-1.0}$	$V_{CC2-0.5}$		V
Output current	I_{O7}	$V_{O7} \geq V_{CC2-1.0}$	300			mA

*1 : All the specification is defined based on the tests performed under the conditions where T_j and T_a ($= 25^\circ C$) are almost equal. These tests were performed with pulse load to minimize the increase of junction temperature (T_j).

*2 : guaranteed by design

*3 : Using resistors of tolerance within 1%.

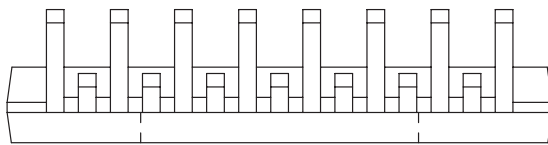
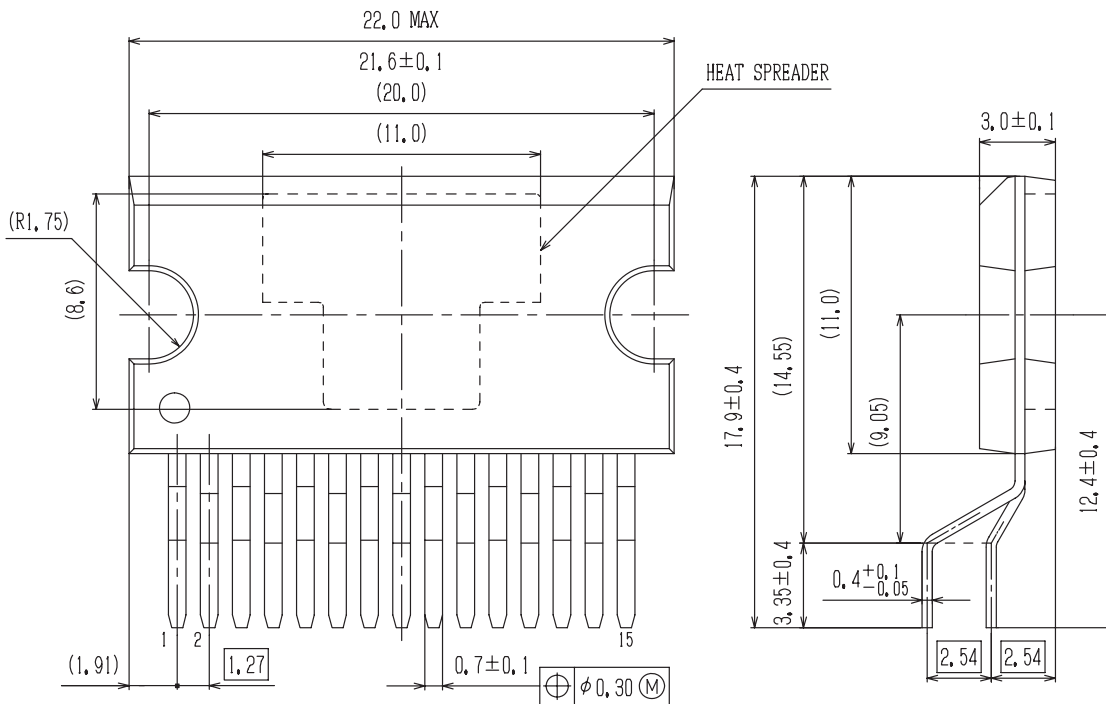
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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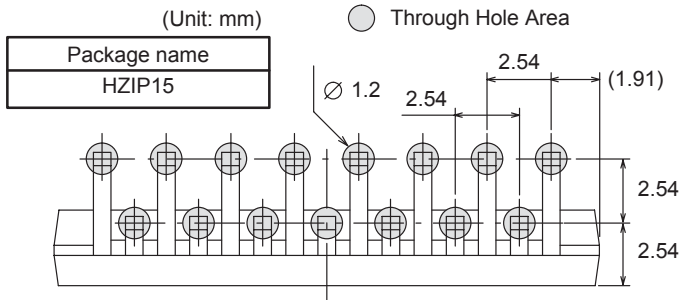
Package Dimensions

unit : mm

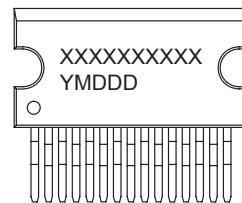
HZIP15
CASE 945AB
ISSUE A



SOLDERING FOOTPRINT*



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
Y = Year
M = Month
DDD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

NOTE: The measurements are not to guarantee but for reference only.

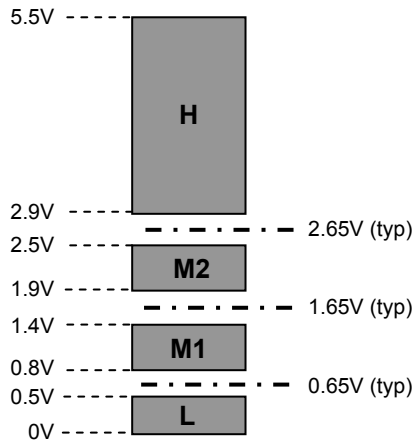
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

CTRL logic truth table

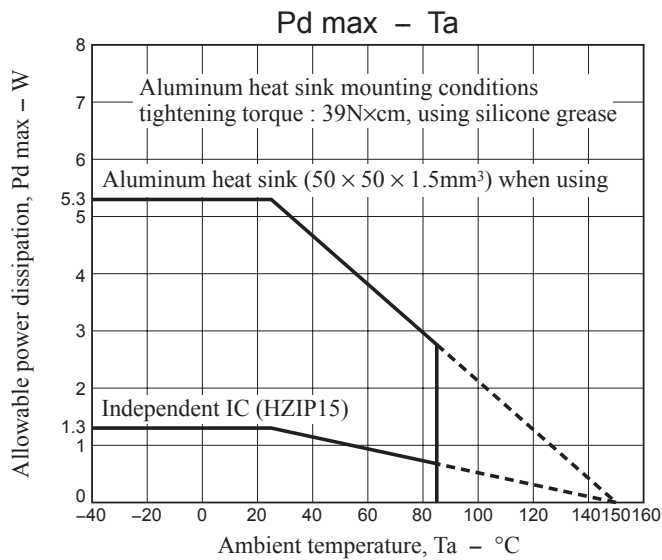
CTRL1	ANT	EXT	ILM
H	ON	ON	ON
M2	OFF	ON	ON
M1	OFF	OFF	ON
L	OFF	OFF	OFF

CTRL2	CD	AUDIO	SW33V
H	ON (8V)	ON	ON
M2	ON (5V)	ON	ON
M1	OFF	ON	ON
L	OFF	OFF	OFF

CTRL1/2 voltage range and threshold

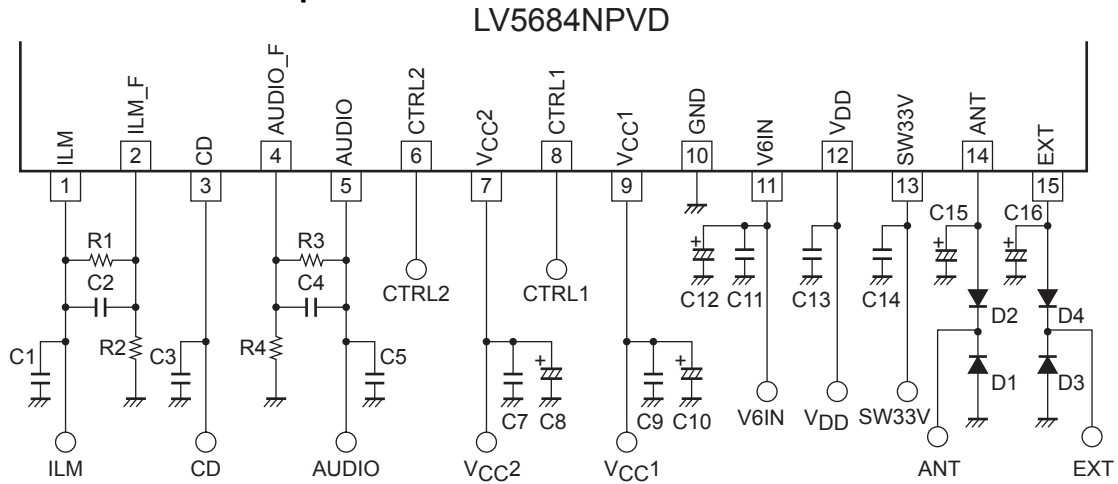


- Allowable power dissipation derating curve



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Application Circuit Example



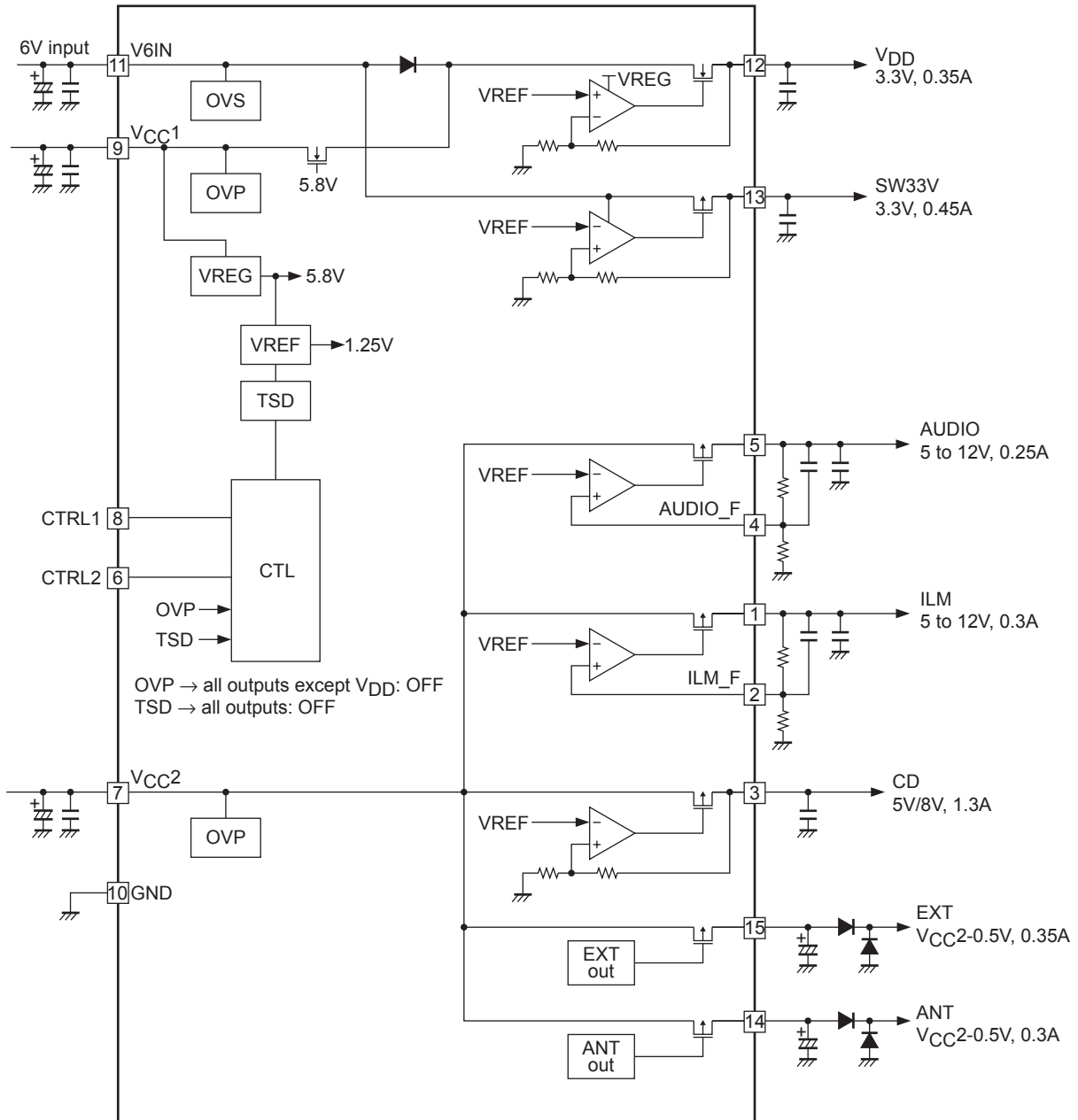
Peripheral parts

Part name	Description	Recommended value	Note
C1, C3, C5, C13, C14	output stabilization capacitor	greater than 10 μ F (*1)	
C2, C4	output stabilization capacitor	0pF	Ceramic capacitor
C8, C10, C12	Capacitor for bypass power supply	C8: greater than 100 μ F C10, C12: greater than 47 μ F	Make sure to implement close to V _{CC} and GND.
C7, C9, C11	Capacitor for oscillation protector	greater than 0.22 μ F	
C15, C16	Capacitor for EXT/ANT output stabilization	greater than 2.2 μ F	
R1, R2	ILM voltage setting	R1/R2 43k Ω /5.1k Ω : V _O = 12V 56k Ω /7.5k Ω : V _O = 10.5V 30k Ω /5.6k Ω : V _O = 8V 30k Ω /10k Ω : V _O = 5V	Use resistors of tolerance within 1%
R3, R4	AUDIO voltage setting	R3/R4 30k Ω /10k Ω : V _O = 5V 27k Ω /4.7k Ω : V _O = 8.5V 43k Ω /5.1k Ω : V _O = 12V	Use resistors of tolerance within 1%
D1, D2, D3, D4	Internal device protector diode	ON Semiconductor SB1003M3	

(*1) Make sure that output capacitors are greater than 10 μ F and meets the condition of ESR = 0.001 to 10 Ω , in which voltage/ temperature dependence and unit differences are taken into consideration. Moreover, in case of electrolytic capacitor, high-frequency characteristics should be sufficiently good.

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Block Diagram



Pin Function

Pin No.	Pin name	Description	Equivalent Circuit
1	ILM	ILM output When CTRL1 = M1, M2, H, ILM is ON	
2	ILM_F	ILM voltage adjust	

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Pin No.	Pin name	Description	Equivalent Circuit
3	CD	CD output When CTRL2 = M2, H, CD is ON 5V or 8V/1.3A	
4	AUDIO_F	AUDIO voltage adjust	
5	AUDIO	AUDIO output When CTRL2 = M1, M2, H, AUDIO is ON	
6	CTRL2	CTRL2 input 4-value input	
7	VCC2	Power supply	
8	CTRL1	CTRL1 input 4-value input	
9	VCC1	Power supply	
10	GND	GND	
11	V6IN	Power supply	

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Pin No.	Pin name	Description	Equivalent Circuit
12	V _{DD}	V _{DD} output 3.3V/0.35A	
13	SW33V	SW33V output When CTRL2 = M1, M2, H, SW33V is ON 3.3V/0.45A	
14	ANT	ANT output When CTRL1 = H, ANT is ON V _{CC} -0.5V/300mA	
15	EXT	EXT output When CTRL1 = M2, H, EXT is ON V _{CC} -0.5V/350mA	

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■Note for VDD output(PIN12) and V6IN (PIN11)

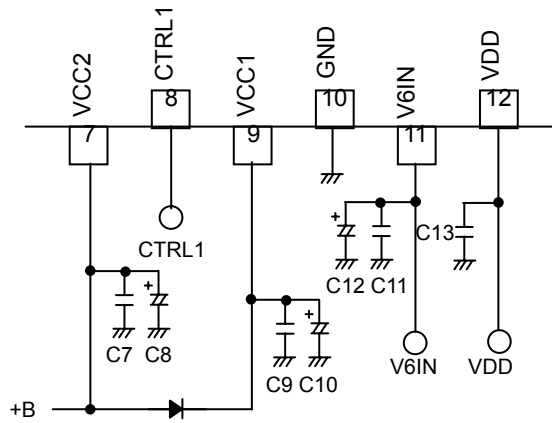
This product doesn't have reverse current prevention feature for the path of VDD to VCC1. As shown above equivalent circuit for PIN12, there exists a parasitic diode from VDD to VCC1. Accordingly if VCC1 voltage drops below approximately $VDD - 0.7V$, reverse current flows from VDD to VCC1. If you need to prevent this current, insert a diode between VCC2 and VCC1 as shown on the figure below.

As the same manner, there is a parasitic diode from V6IN to VCC1.

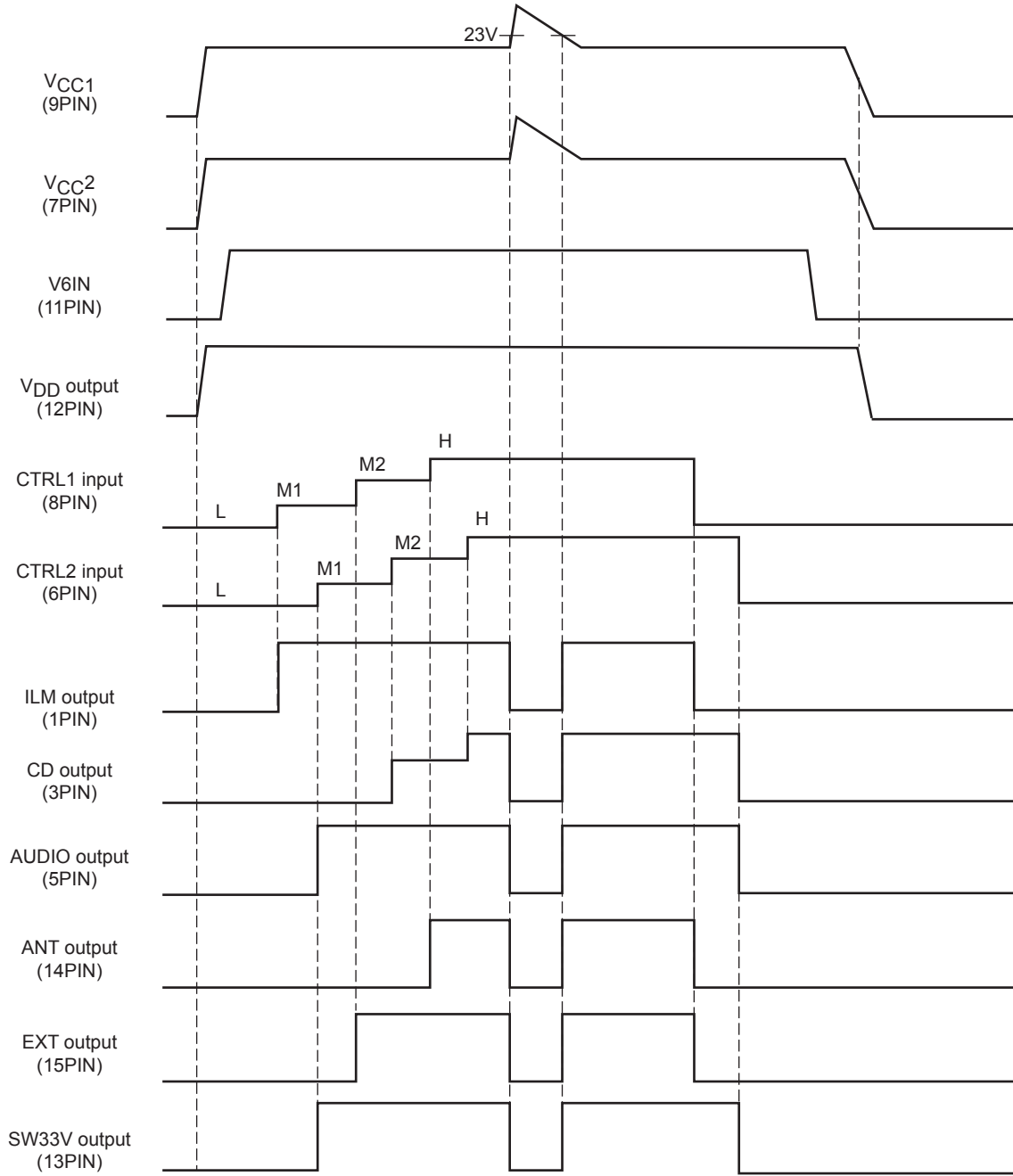
Do not apply voltage to these terminals so that these parasitic diodes are positively biased.

Use under the following condition.

$$VCC \geq VDD, VCC1 \geq V6IN$$



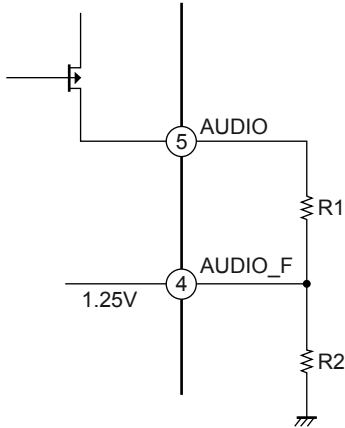
Timing Chart



Caution: The above values are obtained when typ.

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- How to set AUDIO output voltage



AUDIO_F is determined by internal band-gap reference voltage (typ = 1.25V).

AUDIO output voltage expression

$$AUDIO = \left(\frac{R_1}{R_2} + 1\right) \times 1.25[V]$$

$$\frac{R_1}{R_2} = \frac{AUDIO}{1.25} - 1$$

Set the ratio of R1 and R2 to satisfy above expression.

(ex) AUDIO = 9V setting

$$\frac{R_1}{R_2} = \frac{9}{1.25} - 1 = 6.2$$

$$\frac{R_1}{R_2} = \frac{24k\Omega}{3.9k\Omega} \cong 6.15$$

$$AUDIO = (6.15 + 1) \times 1.25V \cong \boxed{8.94V}$$

- ILM output voltage is similarly calculated as AUDIO output.

(ex) ILM = 10.5V setting

$$\frac{R_1}{R_2} = \frac{10.5}{1.25} - 1 = 7.4$$

$$\frac{R_1}{R_2} = \frac{56k\Omega}{7.5k\Omega} \cong 7.46$$

$$ILM = (7.46 + 1) \times 1.25V \cong \boxed{10.575V}$$

Note : The above values are typical values. These values have variation among the range of their tolerances.

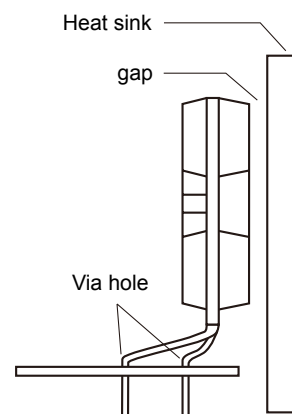
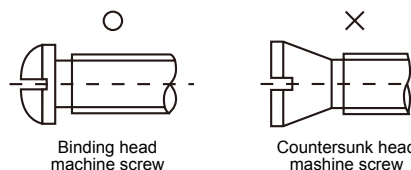
HZIP15 Heat sink attachment

Heat sinks are used to lower the semiconductor device junction temperature by leading the heat generated by the device to the outer environment and dissipating that heat.

- a. Unless otherwise specified, for power ICs with tabs and power ICs with attached heat sinks, solder must not be applied to the heat sink or tabs.

b. Heat sink attachment

- Use flat-head screws to attach heat sinks.
- Use also washer to protect the package.
- Use tightening torques in the ranges 39-59Ncm (4-6kgcm) .
- If tapping screws are used, do not use screws with a diameter larger than the holes in the semiconductor device itself.
- Do not make gap, dust, or other contaminants to get between the semiconductor device and the tab or heat sink.
- Take care a position of via hole .
- Do not allow dirt, dust, or other contaminants to get between the semiconductor device and the tab or heat sink.
- Verify that there are no press burrs or screw-hole burrs on the heat sink.
- Warping in heat sinks and printed circuit boards must be no more than 0.05 mm between screw holes, for either concave or convex warping.
- Twisting must be limited to under 0.05 mm.
- Heat sink and semiconductor device are mounted in parallel.
Take care of electric or compressed air drivers
- The speed of these torque wrenches should never exceed 700 rpm, and should typically be about 400 rpm.



c. Silicone grease

- Spread the silicone grease evenly when mounting heat sinks.
- Recommends YG-6260 (Momentive Performance Materials Japan LLC)

d. Mount

- First mount the heat sink on the semiconductor device, and then mount that assembly on the printed circuit board.
- When attaching a heat sink after mounting a semiconductor device into the printed circuit board, when tightening up a heat sink with the screw, the mechanical stress which is impossible to the semiconductor device and the pin doesn't hang.

e. When mounting the semiconductor device to the heat sink using jigs, etc.,

- Take care not to allow the device to ride onto the jig or positioning dowel.
- Design the jig so that no unreasonable mechanical stress is applied to the semiconductor device.

f. Heat sink screw holes

- Be sure that chamfering and shear drop of heat sinks must not be larger than the diameter of screw head used.
- When using nuts, do not make the heat sink hole diameters larger than the diameter of the head of the screws used. A hole diameter about 15% larger than the diameter of the screw is desirable.
- When tap screws are used, be sure that the diameter of the holes in the heat sink are not too small. A diameter about 15% smaller than the diameter of the screw is desirable.

- g. There is a method to mount the semiconductor device to the heat sink by using a spring band. But this method is not recommended because of possible displacement due to fluctuation of the spring force with time or vibration.

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ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LV5684NPVD-XH	HZIP15 (Pb-Free / Halogen Free)	20 / Fan-Fold

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